



**ALPHA & OMEGA**  
SEMICONDUCTOR

***Alpha & Omega Semiconductor  
Product Reliability qualification  
Report***

**AK6 series**, rev A

**Plastic Encapsulated Device**

**ALPHA & OMEGA Semiconductor, Inc**

**[www.aosmd.com](http://www.aosmd.com)**

This AOS product reliability report summarizes the qualification result for AK6 series. Accelerated environmental tests are performed on a specific sample size, and then followed by electrical test at end point. Review of final electrical test result confirms that AK6 series passes AOS quality and reliability requirements. The released product will be categorized by the process family and be routine monitored for continuously improving the product quality.

## I. Reliability Stress Test Summary and Results

| Test Item          | Test Condition                    | Time Point | Total Sample Size | Number of Failures | Reference Standard |
|--------------------|-----------------------------------|------------|-------------------|--------------------|--------------------|
| HTRB               | Temp = 150°C ,<br>VR=80% of VRmax | 1000 hours | 22 pcs            | 0                  | JESD22-A108        |
| HTSL               | Temp = 150°C                      | 1000 hours | 22 pcs            | 0                  | JESD22-A103        |
| Solderability Test | Temp = 245°C                      | 5 seconds  | 5 pcs             | 0                  | JESD22-B102        |
| RSH                | Temp = 260°C                      | 10 seconds | 5 pcs             | 0                  | JESD22-B106        |

**Note:** The reliability data presents total of available generic data up to the published date.

## II. Reliability Evaluation

**FIT rate (per billion): 160.25**

**MTTF = 712 years**

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size. Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.

**Failure Rate** =  $\text{Chi}^2 \times 10^9 / [2 (N) (H) (Af)] = 160.25$

**MTTF** =  $10^9 / \text{FIT} = 712 \text{ years}$

**Chi<sup>2</sup>** = Chi Squared Distribution, determined by the number of failures and confidence interval

**N** = Total Number of units from burn-in tests

**H** = Duration of burn-in testing

**Af** = Acceleration Factor from Test to Use Conditions (Ea = 0.7eV and Tuse = 55°C)

Acceleration Factor [**Af**] =  $\text{Exp} [Ea / k (1/Tj u - 1/Tj s)]$

**Acceleration Factor ratio list:**

|           | 55 deg C   | 70 deg C  | 85 deg C  | 100 deg C | 115 deg C   | 130 deg C   | 150 deg C |
|-----------|------------|-----------|-----------|-----------|-------------|-------------|-----------|
| <b>Af</b> | <b>259</b> | <b>87</b> | <b>32</b> | <b>13</b> | <b>5.64</b> | <b>2.59</b> | <b>1</b>  |

**Tj s** = Stressed junction temperature in degree (Kelvin), K = C+273.16

**Tj u** = The use junction temperature in degree (Kelvin), K = C+273.16

**k** = Boltzmann's constant,  $8.617164 \times 10^{-5} \text{eV} / \text{K}$

**AK6 series Part No. can refer to below table**

|                 |                 |                 |                 |                 |
|-----------------|-----------------|-----------------|-----------------|-----------------|
| <b>AK6-058C</b> | <b>AK6-076C</b> | <b>AK6-100C</b> | <b>AK6-170C</b> | <b>AK6-190C</b> |
| <b>AK6-240C</b> | <b>AK6-270C</b> | <b>AK6-380C</b> | <b>AK6-430C</b> |                 |